

Title (en)

REGULATION METHOD FOR ADDITIVE MANUFACTURING

Title (de)

REGELUNGSVERFAHREN FÜR DIE ADDITIVE HERSTELLUNG

Title (fr)

PROCÉDÉ DE RÉGULATION POUR LA FABRICATION ADDITIVE

Publication

**EP 3843918 A1 20210707 (DE)**

Application

**EP 19801700 A 20191028**

Priority

- EP 18207810 A 20181122
- EP 2019079341 W 20191028

Abstract (en)

[origin: WO2020104139A1] The invention relates to a regulation method for the additive manufacturing of a component (10). The method comprises: a) acquiring spatially resolved temperature data (T) for a layer (1, 2) built up additively during the manufacture of the component (10); b) determining at least one region-of-interest (ROI) on the layer (1), which is intended to be processed during the manufacture of the component (10); c) classifying temperature values (T, T<sub>1</sub>, T<sub>2</sub>) of the region-of-interest (ROI); d) forming an average value (M) of the classified temperature values (T); and e) controlling a processing device (20) with the formed average value (M) as the input value in order to process the layer (1). The invention further relates to a corresponding device, a computer program product and an additive manufacturing method.

IPC 8 full level

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